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FQA36P15

P-Channel QFET[®] MOSFET -150 V, -36 A, 90 mΩ

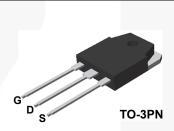
Features

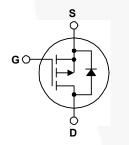
- -36 A, -150 V, $R_{DS(on)}$ = 90 m Ω (Max) @V_{GS} = -10 V, I_D = -18 A This P-Channel enhancement mode power MOSFET is
- Low Gate Charge (Typ. 81 nC)
- Low Crss (Typ. 110 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating

FQA36P15 — P-Channel QFET[®] MOSFET

Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQA36P15	Unit	
V _{DSS}	Drain-Source Voltage		-150	V	
ID	Drain Current - Continuous ($T_C = 25^{\circ}C$)		-36	А	
	- Continuous (T _C = 100°C)		-25.5	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	-144	А	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	1400	mJ	
I _{AR}	Avalanche Current	(Note 1)	-36	A	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	29.4	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-5.0	V/ns	
P _D	Power Dissipation ($T_C = 25^{\circ}C$)		294	W	
	- Derate above 25°C		1.96	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	FQA36P15	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.51	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W	

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Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQA36P15	FQA36P15	TO-3PN	Tube	N/A	N/A	30 units

Electrical Characteristics T_c = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Charac	teristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I _D = -250 µA	-150			V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-0.13		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -150 V, V _{GS} = 0 V			-10	μA
		V_{DS} = -120 V, T_{C} = 150°C			-100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = -25 V, V_{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = 25 V, V_{DS} = 0 V			100	nA
On Charact	eristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -18 A		0.076	0.09	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -40 V, I _D = -18 A		19.5		S
Dynamic Cl	haracteristics					
C _{iss}	Input Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$	-	2550	3320	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		710	920	pF
C _{rss}	Reverse Transfer Capacitance			110	140	pF
Switching C	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = -75 V, I _D = -36 A,		50	110	ns
t _r	Turn-On Rise Time	- R _G = 25 Ω		350	710	ns
t _{d(off)}	Turn-Off Delay Time			155	320	ns
t _f	Turn-Off Fall Time	(Note 4)		150	310	ns
Qg	Total Gate Charge	V _{DS} = -120 V, I _D = -36 A,		81	105	nC
Q _{gs}	Gate-Source Charge	– V _{GS} = -10 V		19		nC
Q _{qd}	Gate-Drain Charge	(Note 4)		42		nC
0	Leven Diode Characteristics and Maximum Ratings	\$	-			
I _S	Maximum Continuous Drain-Source Diode Forward Current				-36	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				-144	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -36 A			-4.0	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = -36 A,$		198		ns
Q _{rr}	Reverse Recovery Charge	$dl_{\rm F}$ / dt = 100 A/µs		1.45		μC

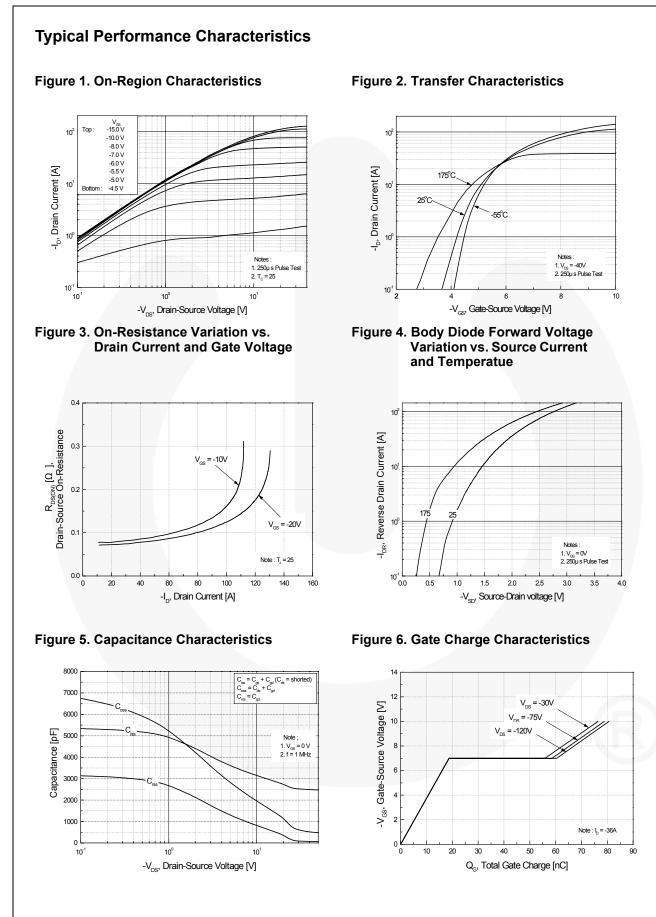
Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. L = 1.45 mH, I_{AS} = -36 A, V_{DD} = -50 V, R_G = 25 $\Omega,$ starting T_J = 25°C.

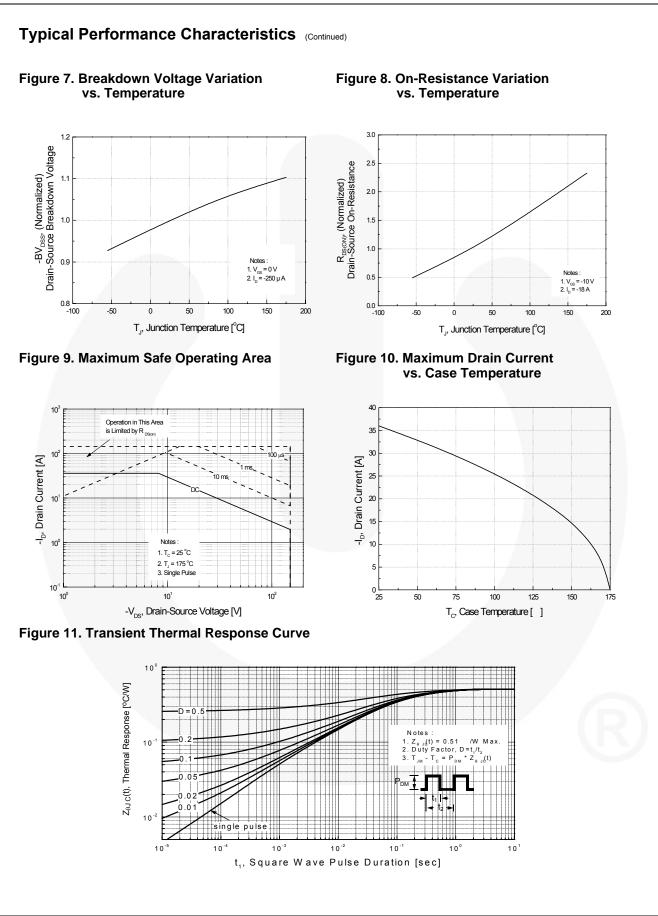
3. $I_{SD} \le$ -36 A, di/dt \le 300 A/µs, $V_{DD} \le$ BV_{DSS}, starting T_J = 25°C.

4. Essentially independent of operating temperature typical characteristics.



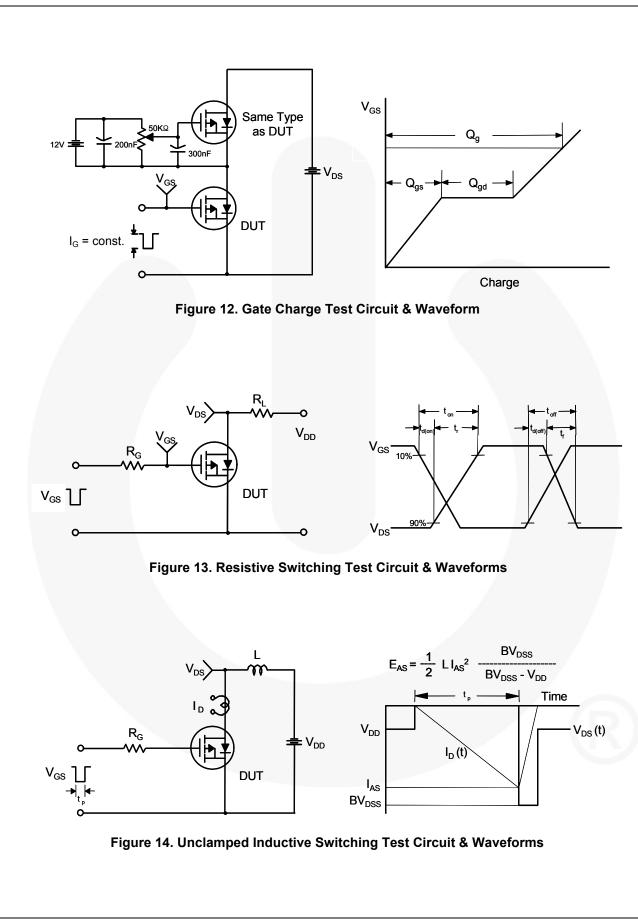
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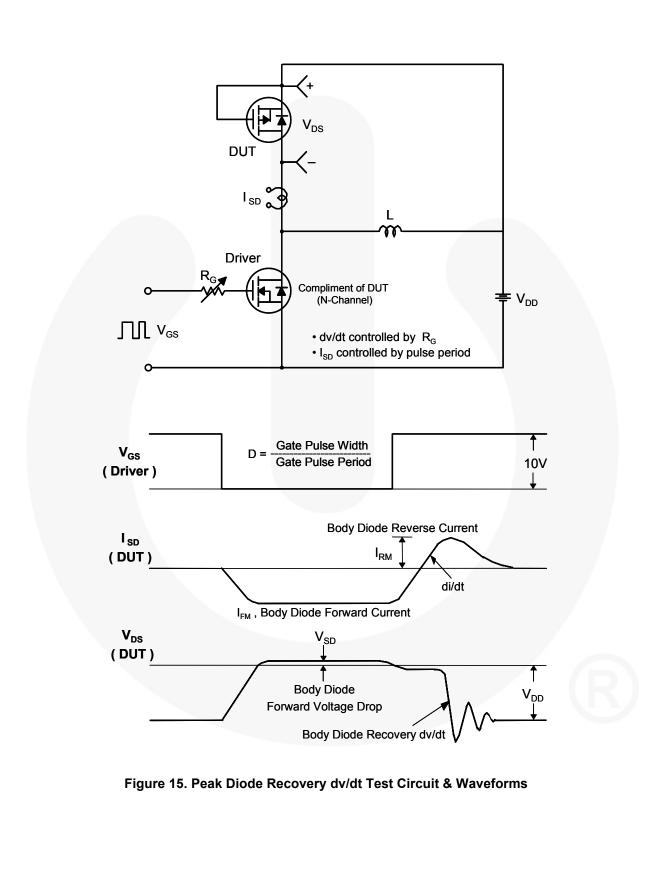
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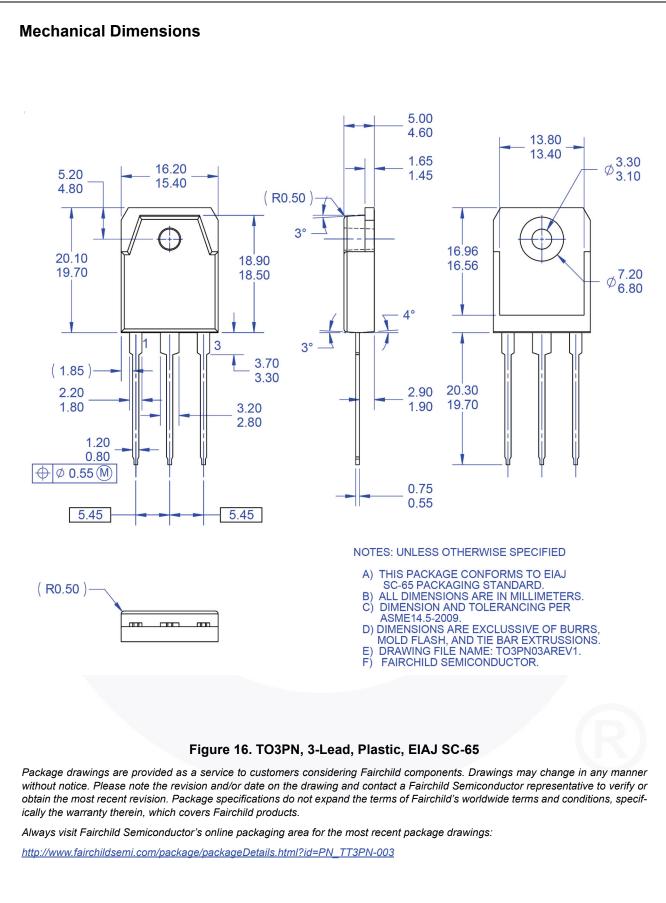


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FQA36P15 — N-Channel QFET[®] MOSFET









No Identification Needed

Obsolete

Full Production

Not In Production

Rev 168